

05-17-2004

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To the Director of

102746727

the attached original documents or copy thereof.

1. Name of conveying party(ies):

Hirohisa MASUDA

5.11.04

Additional name(s) of conveying party(ies) attached? Yes ☐ No ☒

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: April 19, 2004

2. Name and address of receiving party(ies):

Name: **Tokan Material Technology Co., Ltd.**

Internal Address:

Street Address: **1-27, Ohydokita 2-chome, Kita-ku,
Osaka-shi, Osaka, 531-8526, Japan**

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

10842763

If this document is being filed together with a new application, the filing date of the application is May 11, 2004

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Frank J. Jordan, Esq.

Internal Address: Jordan and Hamburg LLP

Chanin Building

Suite 4000

Street Address: 122 East 42nd Street

City: New York State: New York Zip: 10168

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41):.....\$40.00

☐ Enclosed

☒ Authorized to be charged to deposit account

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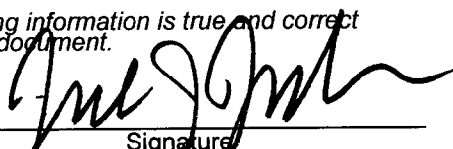
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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Frank J. Jordan, Esq.

Name of Person Signing


Signature

May 11, 2004

Date

Total number of pages including cover sheet, attachments, and documents: 2

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PATENT
REEL: 015322 FRAME: 0570

ASSIGNMENT

For value received, I/we, Hirohisa MASUDA, an individual, with post
office address at c/o Tokan Material Technology Co., Ltd., 1-27, Ohyodokita
2-chome, Kita-ku, Osaka-shi, Osaka, 531-8526, Japan

hereby sell, assign, and transfer to Tokan Material Technology Co., Ltd.,

a corporation existing under the laws of Japan

located at 1-27, Ohyodokita 2-chome, Kita-ku, Osaka-shi, Osaka, 531-8526,
Japan

and its successors, assigns, and legal representatives, the entire right, title, and interest for
all countries including the United States of America, in and to certain inventions relating
to

LEAD-FREE LOW SOFTENING POINT GLASS

described in an application for Letters Patent of the United States,
executed by me/us on this date, and all patents which may be granted therefor, and all
divisions, reissues, continuations and extensions thereof, and authorize and request the
Commissioner of Patents and Trademarks to issue all patents on said improvements or
resulting therefrom to said Company as assignee of the entire interest, and covenant that
I/we have full right so to do, and agree that I/we will communicate to said Company or its
representatives any facts known to us respecting said improvements and testify in any legal
proceedings, sign all lawful papers, execute all divisional, continuing and reissue
applications, make all rightful oaths and generally do everything possible to aid said
Company, its successors, assigns, and nominees, to obtain and enforce proper protection
for said invention in the United States.

Signature

Hirohisa Masuda

Hirohisa MASUDA

Date

04/19/04